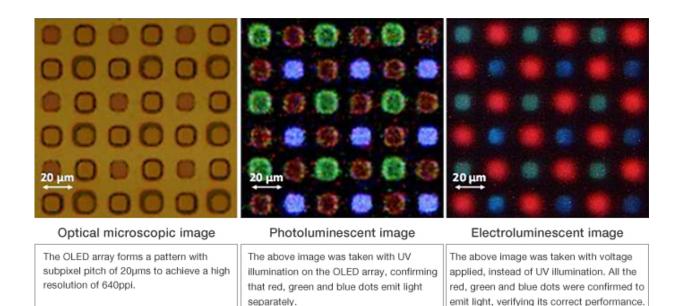


Full-color organic light-emitting diodes with photoresist technology for organic semiconductors

June 2 2015, by Hanne Degans



Fujifilm Corporation and nano-electronics research institute imec have demonstrated full-color organic light-emitting diodes (OLED) by using their jointly-developed photoresist technology for organic semiconductors, a technology that enables submicron patterning. This breakthrough result paves the way to producing high-resolution and large organic Electroluminescent(EL) displays and establishing cost-



competitive manufacturing methods.

Organic EL displays are increasingly used for televisions, mobile devices including smartphones as well as wearable devices. Since they can be made thin and flexible, while also offering excellent response time and <u>contrast ratio</u>. It is said that today's products require organic EL displays of high pixel density, i.e. around 200ppi for 4K televisions, 500ppi for full HD mobile devices and even higher density for compact displays for <u>wearable devices</u>. There has been active R&D for organic semiconductors to develop a high-resolution patterning method for organic EL materials to be used in these products.

In 2013, Fujifilm and imec jointly developed photoresist <u>technology</u> for organic semiconductors that enables submicron patterning without damaging the <u>organic semiconductor</u> materials, based on photolithography capable of high-resolution patterning on large substrates. There is no need for additional capital investment since an existing i-line exposure system can be used for the new technology. This is why the technology has attracted wide attention since the development announcement with anticipation of a cost-effective way of manufacturing high-resolution <u>organic semiconductor</u> devices.

In the latest achievement, Fujifilm and imec produced full-color OLEDs with the photoresist technology for organic semiconductors and successfully verified their performance. Red, green and blue organic EL materials were patterned, each in the subpixel pitch of $20\mu m$, to create full-color OLEDs. An OLED array of 40 x 40 dots at the resolution of 640ppi was realized and illuminated with UV rays to confirm that red, green and blue dots separately emitted light. The emission of red, green and blue lights was also confirmed in a test involving the application of voltage rather than illumination, confirming its correct performance.

These results open new opportunities, such as using the novel



photolithography in a multiple patterning process. An example would be creating an OLED array that adds a fourth color to red, green and blue, as well as developing previously-unseen devices such as a new sensors that integrate OLED with the organic photodetector.

This research result is to be presented at the SID Display Week, one of the world's largest international exhibitions for information displays, held in San Jose, California from May 31 to June 5, 2015.

Since the commencement of joint research in November 2012, Fujifilm and imec have broken through the boundary of conventional technology to contribute to the progress of technology associated with organic semiconductors, e.g., developing the photoresist technology for organic semiconductors that enables the realization of high-resolution submicron patterns. The two companies will continue to undertake cutting-edge R&D involving semiconductor materials, process technology and system integration, thereby contributing to resolving challenges faced by the organic electronics industry.

Provided by FUJIFILM

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